

# MM54HC620/MM74HC620 Inverting Octal TRI-STATE® Transceiver

## MM54HC623/MM74HC623 True Octal TRI-STATE Transceiver

### General Description

These TRI-STATE bi-directional buffers utilize advanced silicon-gate CMOS technology and are intended for two-way asynchronous communication between data buses. They have high drive current outputs which enable high speed operation even when driving large bus capacitances. These circuits possess the low power consumption and high noise immunity usually associated with CMOS circuitry, yet have speeds comparable to low power Schottky TTL circuits. These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus depending on the logic levels at the enable inputs. Both buses can be isolated from each other with proper logic levels at the enable inputs. When GAB is taken high and GBA is taken low, these devices store the states presently appearing at the data inputs. The 8-bit codes appearing on the two sets of buses will be identical for the 623 option or complimentary for the 620 option.

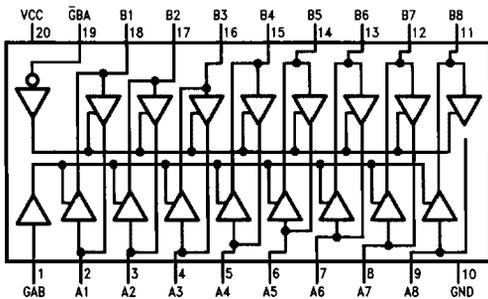
These devices can drive up to 15 LS-TTL loads. All inputs are protected from damage due to static discharge by diodes to  $V_{CC}$  and ground.

### Features

- Typical propagation delays: 13 ns
- Wide power supply range: 2V–6V
- Low quiescent supply current: 80  $\mu$ A maximum (74HC series)
- TRI-STATE outputs for connection to system buses
- High output drive: 6 mA (minimum)

### Connection Diagrams

Dual-In-Line Package



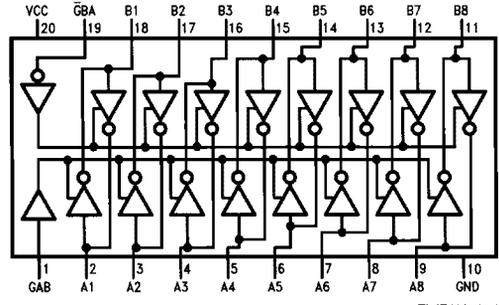
TL/F/9393-1

Top View

Order Number **MM54HC623\*** or **MM74HC623\***

\*Please look into Section 8, Appendix D for availability of various package types.

Dual-In-Line Package



TL/F/9393-2

Top View

Order Number **MM54HC620\*** or **MM74HC620\***

\*Please look into Section 8, Appendix D for availability of various package types.

### Truth Table

Enable Inputs		Operation	
$\bar{G}BA$	GAB		
L	L	$\bar{B}$ data to A bus	B data to A bus
H	H	$\bar{A}$ data to B bus	A data to B bus
H	L	Isolation	Isolation
L	L	$\bar{B}$ data to A bus, A data to B bus	B data to A bus, A data to B bus

MM54HC620/MM74HC620/MM54HC623/MM74HC623

**Absolute Maximum Ratings** (Notes 1 & 2)

If Military/Aerospace specified devices are required, contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage ( $V_{CC}$ )	-0.5V to +7.0V
DC Input Voltage DIR and $\bar{G}$ pins ( $V_{IN}$ )	-1.5V to $V_{CC}$ + 1.5V
DC Output Voltage ( $V_{IN}$ , $V_{OUT}$ )	-0.5 to $V_{CC}$ + 0.5V
Clamp Diode Current ( $I_{CD}$ )	$\pm 20$ mA
DC Output Current, per pin ( $I_{OUT}$ )	$\pm 35$ mA
DC $V_{CC}$ or GND Current, per pin ( $I_{CC}$ )	$\pm 70$ mA
Storage Temperature Range ( $T_{STG}$ )	-65°C to +150°C
Power Dissipation ( $P_D$ )	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature ( $T_L$ )	
(Soldering, 10 seconds)	260°C

**Operating Conditions**

	Min	Max	Units
Supply Voltage ( $V_{CC}$ )	2	6	V
DC Input or Output Voltage ( $V_{IN}$ , $V_{OUT}$ )	0	$V_{CC}$	V
Operating Temp. Range ( $T_A$ )			
MM74HC	-40	+85	°C
MM54HC	-55	+125	°C
Input Rise/Fall Times ( $t_r$ , $t_f$ )			
$V_{CC} = 2.0V$		1000	ns
$V_{CC} = 4.5V$		500	ns
$V_{CC} = 6.0V$		400	ns

**DC Electrical Characteristics** (Note 4)

Symbol	Parameter	Conditions	$V_{CC}$	$T_A = 25^\circ C$			Units	
				74HC $T_A = -40^\circ C$ to $+85^\circ C$		54HC $T_A = -55^\circ C$ to $+125^\circ C$		
				Typ	Guaranteed Limits			
$V_{IH}$	Minimum High Level Input Voltage		2.0V	1.5	1.5	1.5	V	
			4.5V	3.15	3.15	3.15	V	
			6.0V	4.2	4.2	4.2	V	
$V_{IL}$	Maximum Low Level Input Voltage**		2.0V	0.5	0.5	0.5	V	
			4.5V	1.35	1.35	1.35	V	
			6.0V	1.8	1.8	1.8	V	
$V_{OH}$	Minimum High Level Output Voltage	$V_{IN} = V_{IH}$ or $V_{IL}$ $ I_{OUT}  \leq 20 \mu A$	2.0V	2.0	1.9	1.9	V	
			4.5V	4.5	4.4	4.4	V	
			6.0V	6.0	5.9	5.9	V	
		$V_{IN} = V_{IH}$ or $V_{IL}$ $ I_{OUT}  \leq 6.0$ mA $ I_{OUT}  \leq 7.8$ mA	4.5V	4.2	3.98	3.84	3.7	V
			6.0V	5.7	5.48	5.34	5.2	V
$V_{OL}$	Maximum Low Level Output Voltage	$V_{IN} = V_{IH}$ or $V_{IL}$ $ I_{OUT}  \leq 20 \mu A$	2.0V	0	0.1	0.1	V	
			4.5V	0	0.1	0.1	V	
			6.0V	0	0.1	0.1	V	
		$V_{IN} = V_{IH}$ or $V_{IL}$ $ I_{OUT}  \leq 6.0$ mA $ I_{OUT}  \leq 7.8$ mA	4.5V	0.2	0.26	0.33	0.4	V
			6.0V	0.2	0.26	0.33	0.4	V
$I_{IN}$	Input Leakage Current ( $\bar{G}$ and DIR)	$V_{IN} = V_{CC}$ or GND	6.0V	$\pm 0.1$	$\pm 1.0$	$\pm 1.0$	$\mu A$	
$I_{OZ}$	Maximum TRI-STATE Output Leakage Current	$V_{OUT} = V_{CC}$ or GND Enable $\bar{G} = V_{IH}$	6.0V	$\pm 0.5$	$\pm 5.0$	$\pm 10$	$\mu A$	
$I_{CC}$	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu A$	6.0V	8.0	80	160	$\mu A$	

**Note 1:** Maximum Ratings are those values beyond which damage to the device may occur.

**Note 2:** Unless otherwise specified all voltages are referenced to ground.

**Note 3:** Power dissipation temperature derating—plastic "N" package: -12 mW/°C from 65°C to 85°C; ceramic "J" package: -12 mW/°C from 100°C to 125°C.

**Note 4:** For a power supply of 5V  $\pm 10\%$  the worst case output voltages ( $V_{OH}$ , and  $V_{OL}$ ) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case  $V_{IH}$  and  $V_{IL}$  occur at  $V_{CC} = 5.5V$  and 4.5V respectively. (The  $V_{IH}$  value at 5.5V is 3.85V.) The worst case leakage current ( $I_{IN}$ ,  $I_{CC}$ , and  $I_{OZ}$ ) occur for CMOS at the higher voltage and so the 6.0V values should be used.

\*\* $V_{IL}$  limits are currently tested at 20% of  $V_{CC}$ . The above  $V_{IL}$  specification (30% of  $V_{CC}$ ) will be implemented no later than Q1, CY89.

### AC Electrical Characteristics $V_{CC} = 5V, T_A = 25^{\circ}C, t_r = t_f = 6 ns$

Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units
$t_{PHL}, t_{PLH}$	Maximum Propagation Delay	$C_L = 45 pF$		15	ns
$t_{PZH}, t_{PZL}$	Maximum Output Enable Time	$R_L = 1 k\Omega$ $C_L = 45 pF$		31	ns
$t_{PHZ}, t_{PLZ}$	Maximum Output Disable Time	$R_L = 1 k\Omega$ $C_L = 5 pF$		18	ns

### AC Electrical Characteristics $V_{CC} = 2.0V to 6.0V, C_L = 50 pF, t_r = t_f = 6 ns$ unless otherwise specified

Symbol	Parameter	Conditions	$V_{CC}$	$T_A = 25^{\circ}C$			Units
				Typ	74HC $T_A = -40^{\circ}C to +85^{\circ}C$	54HC $T_A = -55^{\circ}C to +125^{\circ}C$	
				Guaranteed Limits			
$t_{PHL}, t_{PLH}$	Maximum Propagation Delay	$C_L = 50 pF$	2.0V	85	105	130	ns
		$C_L = 150 pF$	2.0V	105	130	160	ns
		$C_L = 50 pF$	4.5V	17	21	26	ns
		$C_L = 150 pF$	4.5V	21	26	32	ns
$t_{PZH}, t_{PZL}$	Maximum Output Enable	$R_L = 1 k\Omega$					
		$C_L = 50 pF$	2.0V	170	215	255	ns
		$C_L = 150 pF$	2.0V	195	245	295	ns
		$C_L = 50 pF$	4.5V	34	43	51	ns
$t_{PHZ}, t_{PLZ}$	Maximum Output Disable Time	$C_L = 150 pF$	4.5V	39	49	59	ns
		$C_L = 50 pF$	6.0V	29	37	43	ns
		$C_L = 150 pF$	6.0V	33	42	50	ns
		$R_L = 1 k\Omega$	2.0V	130	165	195	ns
$t_{THL}, t_{TLH}$	Output Rise and Fall Time	$C_L = 50 pF$	4.5V	26	33	39	ns
		$C_L = 50 pF$	6.0V	22	28	33	ns
		$C_L = 50 pF$	2.0V	60	75	90	ns
$C_{PD}$	Power Dissipation Capacitance (Note 5)	$\bar{G}BA, GAB = V_{IL}$	120				pF
		$\bar{G}BA = V_{IH}, GAB = V_{IL}$	12				pF
			5	10	10	10	pF
$C_{IN/OUT}$	Maximum Input/Output Capacitance, A or B		15	20	20	20	pF

**Note 5:**  $C_{PD}$  determines the no load dynamic power consumption,  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} V_{CC} f + I_{CC}$ .